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		FRANSMITTAL LETTER			Docket No. M4065.0319/P319	
Application No. 09/296,835		Filing Date April 22, 1999		Examiner Erik Kielin	Art Unit 2813	
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Thomas J. D'Ar	nico			Dated:	October 2	26, 2004
Attorney Reg. N DICKSTEIN SH		N S USHINGK	VIID			
2101 L Street N	IW		I LLP			
Washington, D((202) 828-2232						



Docket No.: M4065.0319/P319

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Examiner: Erik Kielin

Ronald A. Weimer, et al.

Application No.: 09/296,835

Art Unit: 2813

Filed: April 22, 1999

For: METHOD OF FABRICATING A

SEMICONDUCTOR DEVICE WITH A DIELECTRIC FILM USING A WET

OXIDATION WITH STEAM PROCESS (AS

AMENDED)

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

Commissioner for Patents

MS: <u>Amendment</u> P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

This paper is in response to the Office Action dated July 29, 2004. Please amend the above-identified U.S. patent application as follows:

An Amendment to the Specification is listed on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 7 of this paper.